APPL I CABL	E STANDAF	RD							
	Operating		-55 °C to 85	°C ⁽¹⁾	Operati Humidit	ng y range	Relative humidity 9	95 % N	IAX ⁽³
Rating	Temperature range Voltage		Sto		Storage		-10 °C to 60 °C ⁽²⁾		
	Current		St		Storage		40 % to 70 % ⁽²⁾		
	ourr	one		IFICA	Humidit TIONS	y range			
T	TEM		TEST METHOD	IFIOP		DEO	UIREMENTS	QT	A
						KE4	UTREMENTS	Q I	A
General exa		Visuall	y and by measuring instru	ment	Acco	rding to dra	wing	×	>
Marking		Confirmed visually.						×	,
ELECTRIC	CHARACTER		•						
Contact resistance		100 mA(DC or 1000 Hz)			60	mΩ MAX .		×	- 1
Insulation resistance		100 V DC.			100	100 MΩ MIN.			1-
Voltage proof		150 V	150 V AC FOR 1 min.			No flashover or breakdown.			>
MECHANICA	L CHARACTE	ERISTICS							
Insertion a		Measure	Measured by applicable connector.			Insertion force : 86.4 N MAX.			-
withdrawal forces Mechanical operation		50 tim	50 times insertions and extractions.			Withdrawal force 3.6 N MIN. 1) Contact resistance: 70 mΩ MAX.			-
						2) No damage, crack and looseness of			-
Vibuatian						parts.			
Vibration			Frequency 10 to 55 to 10 Hz, Single amplitude: 0.75 mm, 10 cycles			 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 			-
		For 3 a	For 3 axial directions.						
Shock			490 m/s ² , duration of pulse 11 ms at 3 times for 3 both axial directions.					×	-
	NTAL CHAR			CLIONS.					
Damp heat			Exposed at 40 °C, 90 to 95 %, 96 h.			ontact resis	tance: 70 mΩ MAX.	×	Γ-
(Steady state)							sistance: 100 MΩ MIN.	^	
Rapid change of temperature			Temperature: $-55 \rightarrow +85 \circ C$ Time : $30 \rightarrow 30$ min.			o damage, cr rts.	ack and looseness of	×	-
temperature		Under 5			pa	1 13.			
		•	on time to chamber: With	in 2 to					
Cold		Exposed	Exposed at −55 °C, 96 h			 Contact resistance : 70 mΩ MAX. No damage, crack and looseness of 			-
Dry heat		Exposed	Exposed at +85 °C, 96 h			rts.		×	-
Corrosion salt mist		Exposed	Exposed in 5 $\%$ salt water spray for 48 h.			 Contact resistance : 70 mΩ MAX. No heavy corrosion. 			-
Sulfur dioxide			Exposed 25 ppm, 25 ± 2 °C, 75 ± 5 %RH, for 96 h. (Test standard: JIS C 60068)						-
Resistance to			1) Reflow soldering:			No deformation of case of excessive			-
soldering heat			Peak tmp ∶ 250 °C MAX Reflow tmp: 220 °C MIN for 60sec			eness of the	terminal.		
			ering irons: 360 °C MAX fo						
Solderability			Soldered at solder temperature			A new uniform coating of solder shall			1-
		240 °C	240 °C for immersion duration, 3 sec.			cover a minimum of 95 % of the surface			
Solderabili	ty			sec.	cove		-	×	
COUN	Г	DESCRIPTI	ON OF REVISIONS		DESIGNED	ED CHECKED		DA	ΔTE
									. ,
REMARKS			rise included when energized. indicates a long-term storage state			APPROVED	HT. YAMAGUCHI	2019	
for the unused proc			roduct before the board mounted.				HT. YAMAGUCHI	201910	
Unless other	(3)Non-condens wise specified	•	IEC-60512.			DESIGNED DRAWN	MT. ITANO PENGYU LIU	2019	
	· · · · · · · · · · · · · · · · · · ·					DRAWING NO. ELC-362074-8			
			ICATION SHEET		PART NO.				,
HKS					CODE NO.			·	1/
	-2-1	INVOL LL			OUDE NU.	ULU	10 0007-0-00		יי

FORM HD0011-2-1